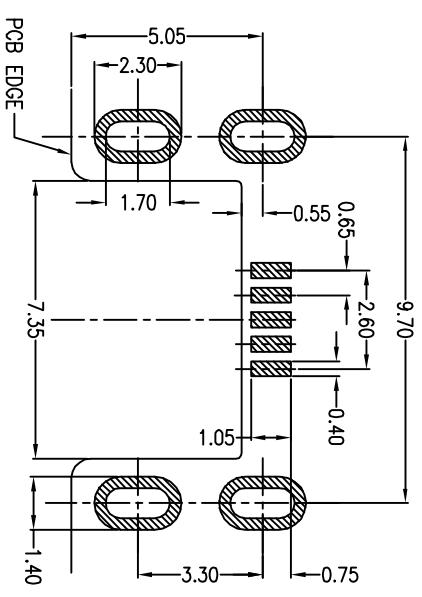
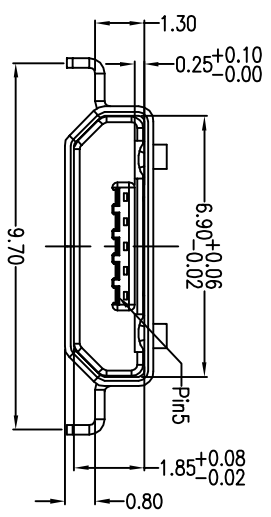
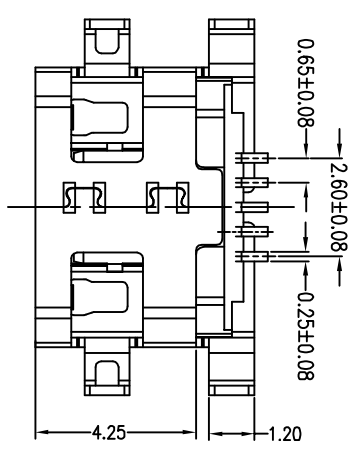
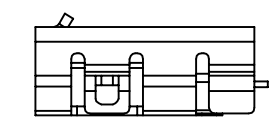
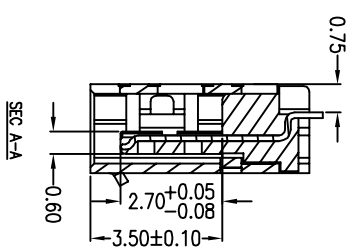
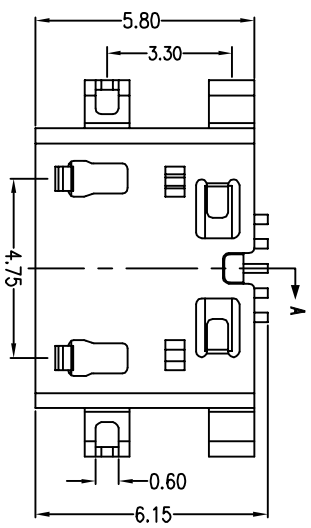
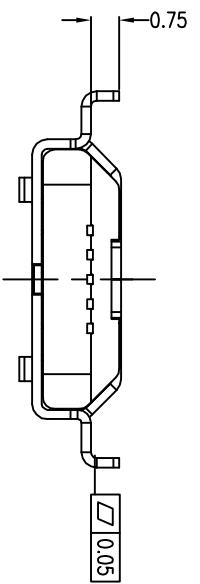


REV.	ECH NO	LOCATIONS	DESCRIPTION	DATE



RECOMMENDED PCB LAYOUT

PCB图仅供参考

- Note:
1. Material:
 - 1.1 Housing: High temperature thermoplastic with g.f.U194V-0
 - 1.2 Contact: copper alloy, t=0.15mm
 - 1.3 Shell: copper alloy, t=0.25mm
 2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 MΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min.
 - 2.7 Temperature range: -30°C~80°C

A 01 S B 1 4 1 B 3-396

- ① 产品代号 A: 成品
- ② 产品系列 01: micro usb 5pin
- ③ 产品类型 S: 母座
- ④ 产品材质 1: 02898R-1/2H
- ⑤ 端子材质 4: 03191R-0H
- ⑥ 主体材质 1: LCP
- ⑦ 主体颜色 B: 黑色
- ⑧ 下板类型 3: 沉板式
- ⑨ 端子序号 308: Silver usb 5p 8 Type 0.8mm间距 0.8mm间距 0.8mm间距 0.8mm间距
- ⑩ 详细材料 308: Silver usb 5p 8 Type 0.8mm间距 0.8mm间距 0.8mm间距 0.8mm间距

深圳市顺安康科技有限公司

TITLE: Micro usb 5p B Type Smt 沉板式 0.8mm间距 全插无导位有孔 双卡点

PART NO:	A01SB141B3-396	MATERIAL:	SEE NOTE
MODEL NO:	XX	FINSH:	SEE NOTE
UNIT:	MM	SIZE:	A4
TOLERANCE UNSPECIFIED	.X	DR:	xiaoyouhong
	.XX	CHK:	
	.XXX	APP:	
	Ang		
	1°		
DWG NO:	SHK-20045	SCALE:	5:1
DATE:	2014.04.15	REV:	A